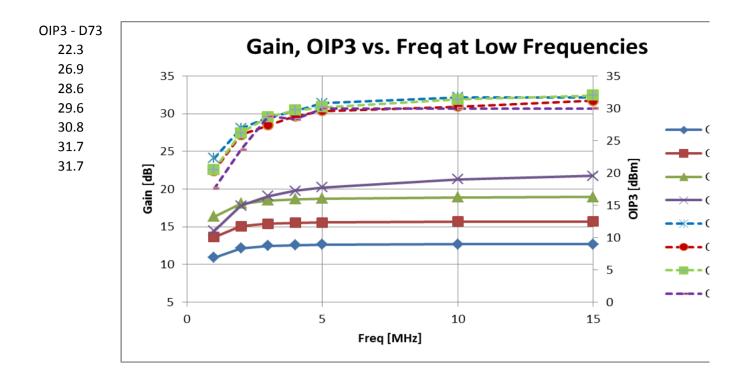
Freq [MHz]	Gain - A73	Gain - B73	Gain - C73	Gain - D73	OIP3 - A73	OIP3 - B73	OIP3 - C73	
1	10.9	13.6	16.4	14.5	17.6	20.3	20.5	
2	12.2	14.5	17.6	17.6	23.6	25.9	26.2	
3	12.5	15.1	18.1	17.8	28.8	27.4	28.7	
4	12.6	15.4	18.5	19.1	28.3	28.8	29.7	
5	12.6	15.5	18.8	19.8	30	29.6	30.2	
10	12.7	15.6	18.9	21.3	30	30.3	31.4	
15	12.7	15.7	18.9	21.8	30	31.2	32	



Gain-A73
Gain-B73
Gain-C73
Gain-C73
DIP3-A73
DIP3-B73
DIP3-C73
DIP3-D73

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